Version: A

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# Specification for Approval

Customer:	
Model Name:	

Supplier Approval			Customer approval
R&D Designed	R&D Approved	QC Approved	
Peter	Peng Jun		



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# **Revision Record**

A	2021-09-10	NEW ISSUE	

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### 1. Scope

This specification defines general provisions as well as inspection standards for TFT module supplied by AMSON electronics.

If the event of unforeseen problem or unspecified items may occur, naturally shall negotiate and agree to solution.

#### 2. General Information

#### I CM

LGIVI		1
ITEM	STANDARD VALUES	UNITS
LCD type	5.0"TFT	
Dot arrangement	800 (RGB)×480	dots
Color filter array	RGB vertical stripe	
Display mode	Normally white TN	-
Gray Scale Inversion Direction	6 O'clock	
Eyes Viewing Direction	12 O'clock	
Driver IC	ILI6122+ILI5960	
Module size	120.7(W)×75.8(H)×5.0(T)	mm
Active area	108(W)×64.80(H)	mm
Dot pitch	0.135(W)×0.135(H)	mm
Interface	24-bit Parallel RGB Interface	
Operating temperature	-20 ~ +70	°C
Storage temperature	-30 ~ +80	°C
Back Light	12 White LED	
Weight	TBD	g

#### **CTP**

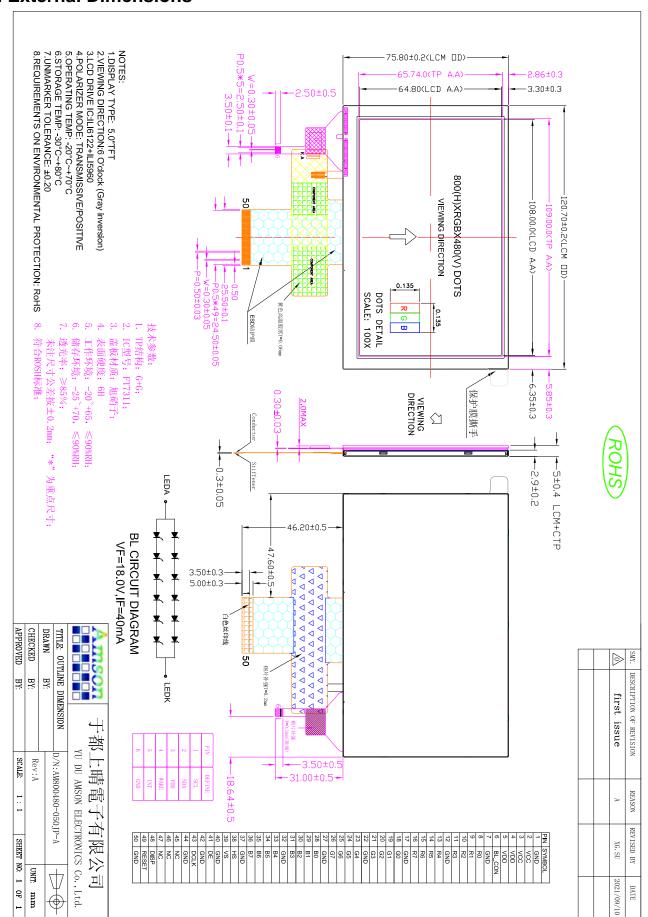
<u> </u>		
ITEM	STANDARD VALUES	
CTP type	Cover Lens + sensor + FPC	
CTP Driver IC	FT7311	
Surface Treatment	6H	
Transmittance	≥85%	
The cover hardness	6H	
CTP size	120.70(W)×75.80(H)×1.95(T)	mm
CTP Active area	109.0(W)×65.74(H)	mm
CTP Interface	I2C	
response time	10	ms



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#### 3. External Dimensions





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## 4. Interface Description

### **TFT**

PIN	PIN NAME	DESCRIPTION
1	GND	Power ground.
2, 3	VCC	Supply Voltage
4, 5	VDD	BL VIN Voltage
6	BL_CON	Common Voltage.
7	GND	Power ground.
8~11	R0~R3	Red Data Input
12	GND	Power ground.
13~16	R4~R7	Red Data Input.
17	GND	Power ground.
18~21	G0	Green Data Input
22	GND	Power ground.
23~26	G4	Green Data Input.
27	GND	Power ground.
28~31	В0	Blue Data Input
32	GND	Power ground.
33~36	B4	Blue Data Input.
37	GND	Power ground.
38	HS	Horizontal sync input. Negative polarity.
39	VS	Vertical sync input. Negative polarity.
40	GND	Power ground.
41	DE	Data Enable signal.
42	GND	Power ground.
43	DCLK	Clock input.
44	GND	Power ground.
45~47	NC.	Not connect.
48	DISP	STANDBY MODE. NORMALLY PULLED HIGH. DISP=H,NORMAL OPERATION.(DEFAULT) DISP=L, TIMING ,CONTORLLER , SOURCE DRIVER WILL TURN OFF,ALL OUTPUT ARE HIGH-Z
49	RESET	Global reset pin. Active low to enter reset state. Suggest to connecting with an RC reset circuit for stability. Normally pull high.(R=10K $\Omega$ , C=1 $\mu$ F)
50	GND	Power ground.



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### **CTP**

Pin	Symbol	Description.		
1	SCL	CTP I <sup>2</sup> C_clock.		
2	SDA	CTP I <sup>2</sup> C_data		
3	VCI	CTP Power Voltage .		
4	WAKE	CTP reset pin. Active low to enter reset state.		
5	INT	CTP interruption signal.		
6	GND	CTP Power ground		

5. Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit
Dower Cumply Voltage	VCC	-0.3	3.6	V
Power Supply Voltage	VDD	-0.3	18	V
CTP Power Voltage	VCI	-0.3	3.6	V
Operating Temperature	Тор	-20	70	°C
Storage Temperature	Тѕт	-30	80	°C
Storage Humidity	HD	-	90	%RH

### 6. DC Characteristics

Item	Symbol	Min.	Тур.	Max.	Unit	Remark
Analog Cunnly Voltago	VCC	3.0	3.3	3.6	V	-
Analog Supply Voltage	VDD	3.0	5.0	15.0	V	-
CTP Power Voltage	VCI	2.8	3.3	3.6	V	-
Input High Voltage	V <sub>IH</sub>	0.7VCC	-	VCC	V	-
Input Low Voltage	$V_{IL}$	GND	-	0.3 VCC	V	-
Output High Voltage	$V_{OH}$	0.8 VCC	-	VCC	V	-
Output Low Voltage	$V_{OL}$	GND	-	0.2 VCC	V	-
Logic Voltage	BL_PWM		3.3V		V	-
PWM Frequency	Fpwm	5		100	KHz	-

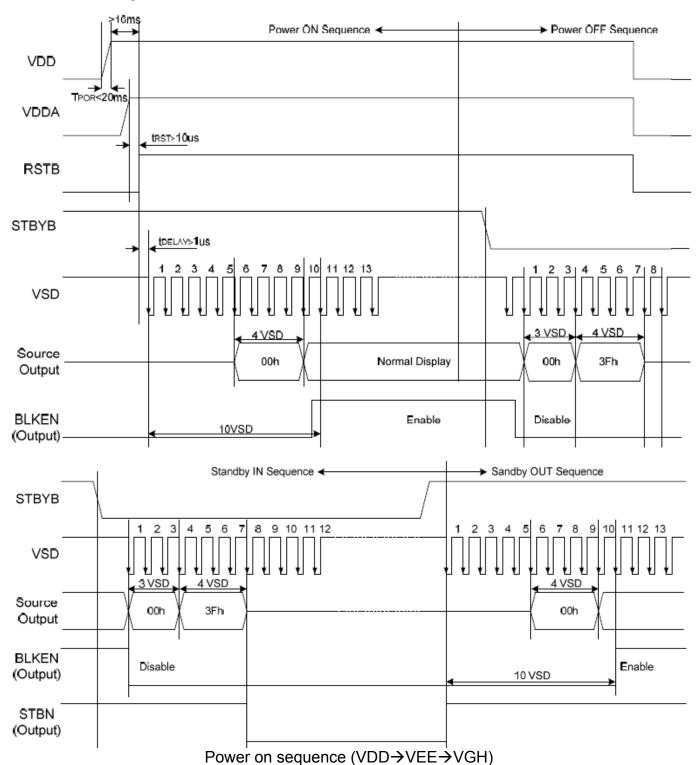
Note: Maximum current from RGB full-display

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## 7. Timing Characteristics

### 7.1 Power Sequence

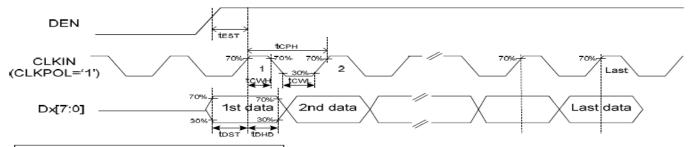


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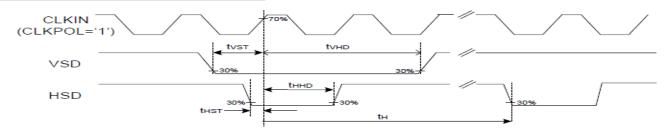
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### 7.2 AC Timing characteristics

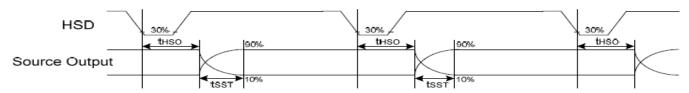
#### DE Mode (MODE='1')



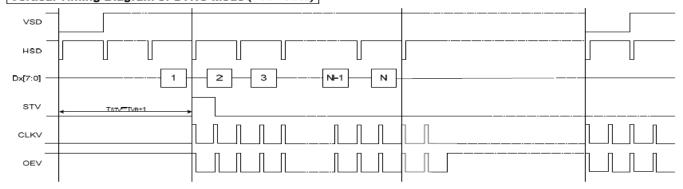
#### SYNC Mode (MODE='0')



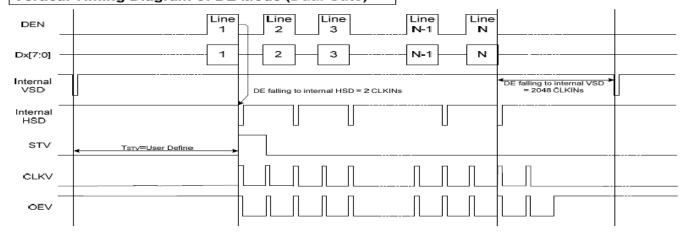
### Source Output timing Diagram (Cascade)



#### Vertical Timing Diagram of SYNC Mode (Dual Gate)



#### Vertical Timing Diagram of DE Mode (Dual Gate)

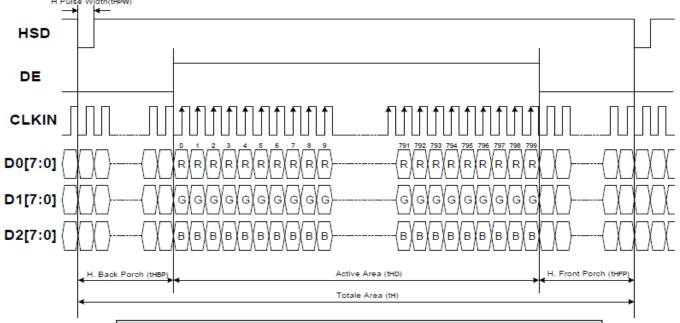




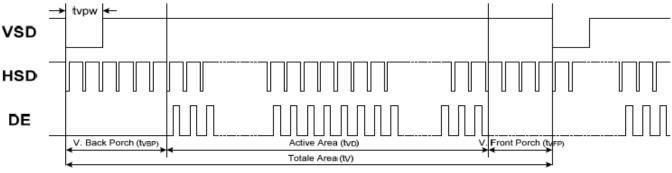
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# 7.3Display Timing characteristics(Resolution: 800x480)



Horizontal Input Timing						
Parameter		Symbol	Value			Unit
Faranie	lei	Symbol	Min.	Typ.	Max.	Offic
Horizontal disp	olay area	t <sub>HD</sub>		800		CLKIN
CLKIN freq	uency	f <sub>CLK</sub>		33.3	50	MHz
1 Horizontal lir	ne period	t <sub>H</sub>	862	1056	1200	CLKIN
LICDI	Min.	t <sub>HPW</sub>		1		CLKIN
HSD pulse width	Typ.					CLKIN
width	Max.			40		CLKIN
HSD back porch	SYNC	t <sub>HBP</sub>	46	46	46	CLKIN
HSD front	SYNC	t <sub>HFP</sub>	16	210	354	CLKIN



Vertical Input Timing							
Parameter	Symbol		Value	Unit			
Farameter	Syllibol	Min.	Тур.	Max.	Offic		
Vertical display area	t <sub>VD</sub>		480	-	HSD		
VSD period time	t <sub>V</sub>	510	525	650	HSD		
VSD pulse width	t <sub>vpw</sub>	1		20	HSD		
VSD back porch	$t_{VBP}$	23	23	23	HSD		
VSD front porch	t <sub>VFP</sub>	7	22	147	HSD		

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## 7.4CTP Timing characteristics 7.4.1 Serial Interface I<sup>2</sup>C

FT7311 supports the I2C interfaces, which can be used by a host processor or other devices.

The I2C is always configured in the Slave mode. The data transfer format is shown in **Figure 2-4**.

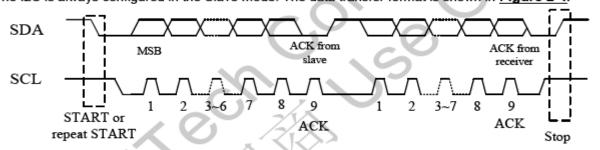


Figure 2-4 I2C Serial Data Transfer Format

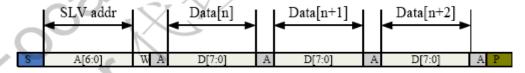


Figure 2-5 I2C master write, slave read

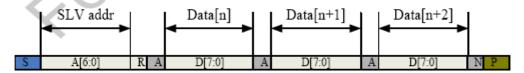


Figure 2-6 I2C master read, slave write

## **Mnemonics Description**

Mnemonics	Description
s	I2C Start or I2C Restart
A[6:0]	Slave address
R/W	READ/WRITE bit, '1' for read, '0' for write
A(N)	ACK(NACK) bit
Р	STOP: the indication of the end of a packet (if this bit is missing, S will indicate the end of the current packet and the beginning of the next packet)

## **Timing Characteristics**

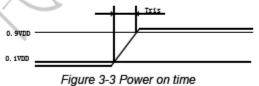
Parameter	Min	Max 🐁	Unit
SCL frequency	0	400	KHz
Bus free time between a STOP and START condition	1.3		us
Hold time (repeated) START condition	0.6		us
Data setup time	100		ns
Setup time for a repeated START condition	0.6		us
Setup time for STOP condition	0.6		us
Rise time of both SDA and SCL signals	20	300	ns
Fall time of both SDA and SCL signals	20x (VDD/5.5V)	300	ns

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### 7.4.2 POWER NO /Reset/Wake Sequence

Reset should be pulled down to be low before powering on and powering down. I2C shouldn't be used by other devices during Reset time after VDD powering on (Trtp). INT signal will be sent to the host after initializing all parameters and then start to report points to the host. If Power is down, the voltage of supply must be below 0.3V and Tpdt is more than 1ms.



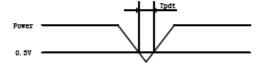


Figure 3-4 Power Cycle requirement

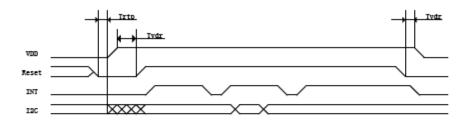


Figure 3-5 Power on Sequence

Reset time must be enough to guarantee reliable reset, the time of starting to report point after resetting approach to the time of starting to report point after powering on.

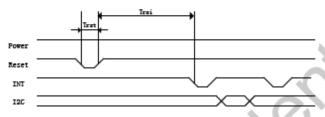


Figure 3-6 Reset Sequence

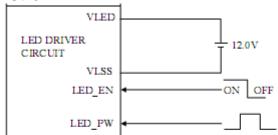
### **Power on/Reset Sequence Parameters**

Parameter	Description	Min	Max	Units
Tris	Rise time from 0.1VDD to 0.9VDD	0.	5	ms
Tpdt	Time of the voltage of supply being below 0.3V	5	-	ms
Trtp	Time of resetting to be low before powering on	100	-	μS
Tvdr	Reset time after VDD powering on	1	-	ms
Trsi	Time of starting to report point after resetting		200	ms
Trst	Reset time	1		ms

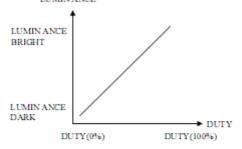
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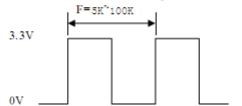
### 8. Backlight Characteristic



NOTE (1): ADJUST THE PWM SIGNAL IN ORDER TO CONTROL LED BACKLIGHT'S BRIGHTNESS. THE HIGHER THE DUTY CYCLE, THE HIGHER THE BRIGHTN LUMIN ANCE



NOTE (2): PWM SIGNAL=0~3.3V · OPERATION FREQUENCY: 5K~100K



Item		Symbol	MIN	TYP	MAX	UNIT	NOTE
Backlight Power		LED_VCC	3	5	15	V	Ta = 25°C
		==	-	(0.15)	(0.2)	Α	LED_VCC=5V
Backlight Pow	er	ILED_VCC	-	(0.07)	(0.1)	Α	LED_VCC=12 V
EN Signal Volta	VIH	DI CON	1.2			V	
ge	VIL	BL_CON	GND		0.4	V	
PWM Frequen	су	LED_PWM	5		100	KHz	
Lifetime			50000	-	-	Hr	
Color			Wh	nite			
Average Brightness		-	350	450	-	Cd/cm2	
Luminance unifo	rmity	-		80	-	%	



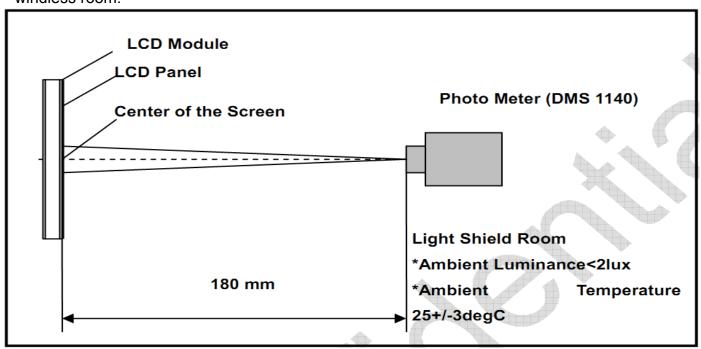
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9. Optical Characteristics

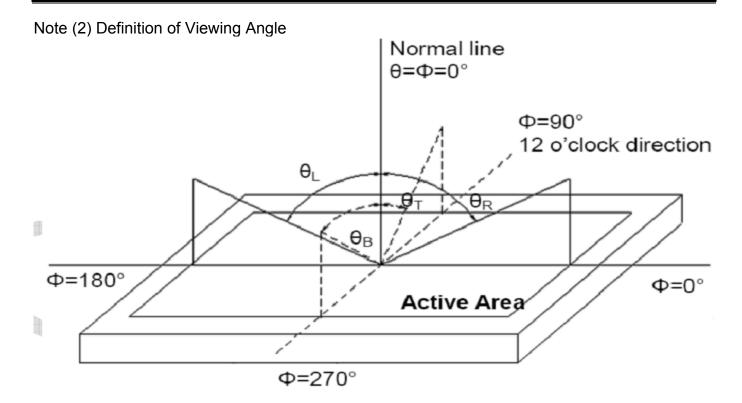
Item	Conditions		Min.	Тур.	Max.	Unit	Note	
	Horizontal	θL	1	70	-			
Viewing Angle	Tionzoniai	θR	-	70	-	d	(4) (2) (6)	
(CR>10)	Vertical	θт	-	50	-	degree	(1),(2),(6)	
	vertical	θв	-	70	-			
Contrast Ratio	Center		400	500	-	ı	(1),(3),(6)	
Response Time	Rising		1	10	20	ms	(1),(4),(6)	
	Falling		-	15	30			
	Red x			TBD		-		
	Red y	Red y		TBD		-		
	Green x			TBD	- - -	-		
CF Color	Green y			TBD		-	(1) (6)	
Chromaticity (CIE1931)	Blue x		Тур.		Тур.	-	(1), (6)	
	Blue y		-0.05	TBD	+0.05	-		
	White x			TBD		-		
	White y			TBD		-		
NTSC				61.	-	%	(1),(6)	

Note (1) Measurement Setup: The LCD module should be stabilized at given temp. 25°C for 15 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting backlight for 15 minutes in a windless room.



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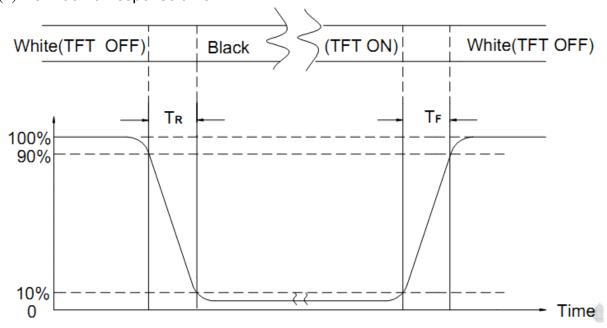


Note (3) Definition of Contrast Ratio (CR)

The contrast ratio can be calculated by the following expression Contrast Ratio (CR) = L63 / L0

L63: Luminance of gray level 63, L0: Luminance of gray level 0

Note (4) Definition of response time



Note (5) Definition of Transmittance (Module is without signal input)

Transmittance = Center Luminance of LCD / Center Luminance of Back Light x 100%

Note (6) Definition of color chromaticity (CIE1931)

Color coordinates measured at the center point of LCD



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10. Reliability Test Conditions and Methods

NO.	TEST ITEMS	TEST CONDITION	INSPECTION AFTER TEST
	High Temperature Storage	80°C±2°C×96Hours	
	Low Temperature Storage	-30°C±2°C×96Hours	
	High Temperature Operating	70°C±2°C×96Hours	
	Low Temperature Operating	-20°C±2°C×96Hours	Inspection after 2~4hours storage at room temperature, the samples
	Temperature Cycle(Storage)	-20°C $\longrightarrow$ 25°C $\longrightarrow$ 70°C (30min) (30min) 1cycle Total 10cycle	should be free from defects: 1, Air bubble in the LCD. 2, Seal leak. 3, Non-display. 4, Missing segments.
	Damp Proof Test (Storage)	50°C±5°C×90%RH×96Hours	<ul><li>5, Glass crack.</li><li>6, Current IDD is twice</li></ul>
	Vibration Test	Frequency:10Hz~55Hz~10Hz Amplitude:1.5MM X,Y,Z direction for total 3hours (packing condition test will be tested by a carton)	higher than initial value. 7, The surface shall be free from damage. 8, The electric characteristic requirements shall be satisfied.
	Drooping Test	Drop to the ground from 1M height one time every side of carton.  (packing condition test will be tested by a carton)	orian be satisfied.
	ESD Test	Voltage:±8KV,R:330Ω,C:150PF,Air Mode,10times	

#### REMARK:

- 1, The Test samples should be applied to only one test item.
- 2, Sample side for each test item is 5~10pcs.
- 3,For Damp Proof Test, Pure water(Resistance  $> 10M\Omega$ )should be used.
- 4,In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judge as a good part.
- 5, EL evaluation should be accepted from reliability test with humidity and temperature: Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and Fluorescence EL has.
- 6, Failure Judgment Criterion: Basic Specification Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.



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#### 11. Inspection Standard

#### 11.1. QUALITY:

THE QUALITY OF GOODS SUPPLIED TO PURCHASER SHALL COME UP TO THE FOLLOWING STANDARD.

#### 11.1.1. INSPECTIONTOOLS AND INSTRUMENTS

Vernier calipers, film scales, multimeter, magnifying eyepiece, ND5%, luminance meter and so on.

#### 11.1.2. THE METHOD OF PRESERVING GOODS

AFTER DELIVERY OF GOODS FROM AMSON TO PURCHASER. PURCHASER SHALL CONTROL THE LCM AT -10 TO 40 ,AND IT MIGHT BE DESIRABLE TO KEEP AT THE NORMAL ROOM TEMPERATURE AND HUMIDITY UNTIL INCOMING INSPECTION OR THROWING INTO PROCESS LINE.

#### 11.1.3. INCOMING INSPECTION

(A) THE METHOD OF INSPECTION

IF PURCHASER MAKE AN INCOMING INSPECTION, A SAMPLING PLAN SHALL BE APPLIED ON THE CONDITION THAT QUALITY OF ONE DELIVERY SHALL BE REGARDED AS ONE LOT.

(B) THE STANDARD OF QUALITY

ISO-2859-1 (SAME AS MIL-STD-105E), LEVEL: II

CLASS	AQL(%)
CRITICAL	0.4 %
MAJOR	0.65 %
MINOR	1.5 %

EVERY ITEM SHALL BE INSPECTED ACCORDING TO THE CLASS.

(C) MEASURE

IF AS THE RESULT OF ABOVE RECEIVING INSPECTION, A LOT OUT IS DISCOVERED. PURCHASER SHALL BE INFORM SELLER OF IT WITHIN SEVEN DAYS. BUT FIRST SHIPMENT WITHIN FOURTEEN DAYS.

#### 11.1.4. WARRANTY POLICY

AMSON WILL PROVIDE ONE-YEAR WARRANTY FOR THE PRODUCTS ONLY IF UNDER SPECIFICATION OPERATING CONDITIONS. AMSON WILL REPLACE NEW PRODUCTS FOR THESE DEFECT PRODUCTS WHICH UNDER WARRANTY PERIOD AND BELONG TO THE RESPONSIBILITY OF AMSON.

#### 11.2. CHECKING CONDITION

- **11.2.1.**CHECKING DIRECTION SHALL BE IN THE 45 DEGREE AREA TO FACE THE SAMPLE.
- **11.2.2.**CHECKER SHALL SEE OVER 300±25 mm. WITH BARE EYES FAR FROM SAMPLE **11.2.3.**Ambient Illumination:

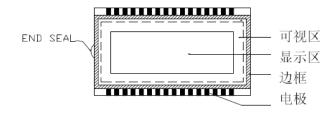
Z.J.Ambient munimation.

0 ~30 Lux for functional inspection

500 ~ 1200 Lux for external appearance inspection.

#### **11.2.4.** TEST AREA:

**11.2.5.** Inspection should be carried out with rope electrostatic ring and static finger cover (both hands except small fingers must be worn)





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- **11.2.6.** The inspector may make a visual inspection or a comparative examination with a film ruler and a magnifying eyepiece. Individual defects shall be determined according to the limited samples.
- **11.2.7.** Functional testing uses electrical testing fixtures or test fixtures required by customers.
- **11.2.8.** the ion fan should be used when testing.

## 11.2.9. the principle of judgment

11.3.1 If the defect outside the visual area does not affect the assembly and display, it will be judged as a good product.

11.3.2 Poor definition

Pixel:

A combination of three sub-pixels (Red + Green + Blue).



#### Dot:

Any of the sub-pixels (Red or Green or Blue).







### **Bright and dark dots:**

A point pixel (sub-pixel: R, G, B pixels) is lit or turned off during the display function test. **Highlights**:

Usually considered to be shown on a black screen.

### Dark spots:

They are generally considered to be shown on R, G, B solid colors or white images.

#### Neighborhood:

Two or three adjacent point pixels (dot: sub-pixel) connected together (R, G or G, B or B, R or RGB).



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#### 11.3. INSPECTION PLAN:

11.0. II 401 E0	TION PLAN :		
CLASS	ITEM	JUDGEMENT	CLASS
PACKING &	1. OUTSIDE AND INSIDE PACKAGE	"MODEL NO." , "LOT NO." AND "QUANTITY" SHOULD INDICATE ON THE PACKAGE.	Minor
INDICATE	2. MODEL MIXED AND QUANTITY	OTHER MODEL MIXEDREJECTED  QUANTITY SHORT OR OVERREJECTED	Critical
	3. PRODUCT INDICATION	"MODEL NO." SHOULD INDICATE ON THE PRODUCT	Major
ASSEMBLY	4. DIMENSION, LCD GLASS SCRATCH AND SCRIBE DEFECT.	ACCORDING TO SPECIFICATION OR DRAWING.	Major
	5. VIEWING AREA	POLARIZER EDGE OR LCD'S SEALING LINE IS VISABLE IN THE VIEWING AREAREJECTED	Minor
	6. BLEMISH · BLACK SPOT · WHITE SPOT IN THE LCD AND LCD GLASS CRACKS	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
APPEARANCE	7. BLEMISH · BLACK SPOT WHITE SPOT AND SCRATCH ON THE POLARIZER	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
	8. BUBBLE IN POLARIZER	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
	9. LCD'S RAINBOW COLOR	STRONG DEVIATION COLOR ( OR NEWTON RING) OF LCDREJECTED.  OR ACCORDING TO LIMITED SAMPLE ( IF NEEDED, AND INSIDE VIEWING AREA )	Minor
	10. ELECTRICAL AND OPTICAL CHARACTERISTICS ( CONTRAST, VOP, CHROMATICITY ETC )	ACCORDING TO SPECIFICATION OR DRAWING . ( INSIDE VIEWING AREA )	Critical
ELECTRICAL	11.MISSING LINE	MISSING DOT: LINE : CHARACTERREJECTED	Critical
	12.SHORT CIRCUIT WRONG PATTERN DISPLAY	NO DISPLAY - WRONG PATTERN  DISPLAY - CURRENT CONSUMPTION  OUT OF SPECIFICATION REJECTED	Critical
	13. DOT DEFECT (FOR COLOR AND TFT)	ACCORDING TO STANDARD OF VISUAL INSPECTION	Minor



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NO.	CLASS	ITEM	JUDGEMENT			
М			(A) ROUND TYPE: unit : mm.			
			DIAMETER (mm.) ACCEPTABLE Q'TY  Φ ≤ 0.15 Distance≥1mm			
			$0.15 < \Phi \leq 0.4$ 3 (Distance>15mm)			
		BLACK AND WHITE SPOT	0.4 < Φ 0			
		FOREIGN MATERIEL	NOTE: Φ=(LENGTH+WIDTH)/2			
11.4.1	MINOR	DUST IN THE CELL BLEMISH	(B) LINEAR TYPE: unit : mm.			
		SCRATCH	LENGTH WIDTH ACCEPTABLE Q'TY			
		SORATOTI	W ≦0.03 Distance≥1mm			
			$L \le 4.0 \ 0.03 < W \le 0.05 \ 3 \ (Distance>15mm)$			
			0.05 < W FOLLOW ROUND TYPE			
Ш						
			unit : mm.			
			DIAMETER ACCEPTABLE Q'TY			
11.42	11.4.2 MINOR	BUBBLE IN POLARIZER	Φ ≤ 0.2 Distance≥1mm			
11.4.2	MINOR	DENT ON POLARIZER	0.2 < Φ ≤ 0.3 3 (Distance>15mm)			
			0.3 < Φ 0			
			Items ACC. Q'TY			
		Dot Defect	Bright dot N≤2 (Distance≥15mm)			
			Dark dot N≤3 (Distance>15mm)			
			Pixel Define : Pixel			
			R G B			
11 4 3	MINOR		◆ Dot → ◆ Dot →			
			Note 1: The definition of dot: The size of a defective dot over			
			1/2 of whole dot is regarded as one defective dot.			
			Definittion:<1/2dot and visible by 5 % ND filter N ≦ 5			
			Note 2: Bright dot: Dots appear bright and unchanged in size			
			in which LCD panel is displaying under black pattern.			
			Note 3: Dark dot: Dots appear dark and unchanged in size in			
			which LCD panel is displaying under pure red, green			
			,blue pattern.			
П		More	Not visible thriugh 5% ND filter in 50% gray or judge			
11.4.4	MINOR	Mura	by limit sample if necessary			
oxed			,			



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NO.	CLASS	ITEM	JUDGEMEN	Т
11.4.4	MINOR	LCD GLASS CHIPPING	S	Y > S Reject
11.4.5	MINOR	LCD GLASS CHIPPING	SY	X or Y > S Reject
11.4.6	MAJOR	LCD GLASS GLASS CRACK	Y	Y > (1/2) T Reject
11.4.7	MAJOR	LCD GLASS SCRIBE DEFECT	A + + B	1. a> L/3 , A>1.5mm. Reject  2. B: ACCORDING TO DIMENSION
11.4.8	MINOR	LCD GLASS CHIPPING ( ON THE TERMINAL AREA )	T	$\Phi$ = (x+y)/2 > 2.5 mm Reject
11.4.9	MINOR	LCD GLASS CHIPPING ( ON THE TERMINAL SURFACE )	T Z X	Y > (1/3) T Reject
11.4.10	MINOR	LCD GLASS CHIPPING	T Z	Y > T Reject



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## 12. Handling Precautions

### 12.1 Mounting method

The LCD panel of AMSON TFT module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

### 12.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent

[Recommended below] and wipe lightly

- Isopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water
- Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns Do not use the following solvent on the pad or prevent it from being contaminated:

- Soldering flux
- Chlorine (CI), Sulfur (S)

If goods were sent without being silicon coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Sulfur (S) from customer, Responsibility is on customer.

#### 12.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you:

Connect any unused input terminal to power or ground, do not input any signals before power is turned on, and ground your body, work/assembly areas, and assembly equipment to protect against static electricity.

#### 12.4 packing

- Module employs LCD elements and must be treated as such.
- Avoid intense shock and falls from a height.
- To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity

#### 12.5 Caution for operation

- It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.
- An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.
- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- Slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.
  - Usage under the maximum operating temperature, 50%Rh or less is required.



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#### 12.6 storing

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

- Storage in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it. And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- Storing with no touch on polarizer surface by the anything else.
   [It is recommended to store them as they have been contained in the inner container at the time of delivery from us.

#### 12.7 Safety

- It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water.

#### 13. Precaution for Use

#### 13.1

A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

#### 13.2

On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

- When a question is arisen in this specification.
- When a new problem is arisen this is not specified in this specification.
- When an inspection specifications change or operating condition change in customer is reported to AMSON TFT and some problem is arisen in this specification due to the change.
- When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

# 14. Packing Method TBD